SSP0700B-1024600 Series SPI TFT LCD Module USER MANUAL IPS

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Reference Controller Datasheet

SPI TFT LCD Module Selection Guide

LT7680A

GT911

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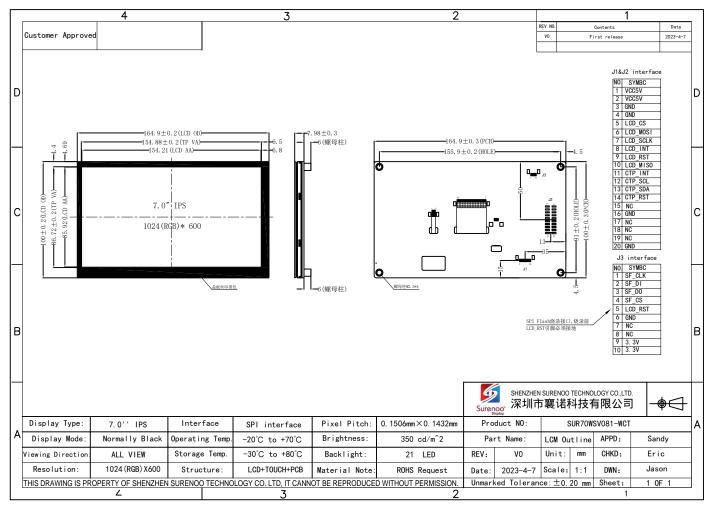
1, GENERAL INFORMATION

Item of general information		Contents	Unit	
LCD Display Size (Diagonal)		7.0"		
Module Structure		LCD + TOUCH + PCB	-	
LCD Display Type		TFT/TRANSMISSIVE	-	
LCD Display Mode		Normally Black	-	
Recommended Viewing Direction		ALL VIEW	o'clock	
	LTP	178.80×110.72×7.98	mm	
Modulo sizo (W×H×T)	СТР	164.90×100.00×7.98	mm	
Module size (W×H×T)	RTP	164.90×100.00×7.98	mm	
	NTP	164.90×100.00×5.98	mm	
Active area (W×H)		154.21×85.92	mm	
Number of pixels (Resolution)		1024(RGB)×600	pixel	
Pixel pitch (W×H)		0.1506×0.1432	mm	
LCD Driver IC		-	-	
Module Interface Type		-		
Module Input voltage		5.0V	V	
Module Power consumption	-		mW	
Color Numbers		-		
Backlight Type		White LED	-	

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2, EXTERNAL DIMENSIONS



3 ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	Tst -30		°C
Humidity	RH	-	90% (Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

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4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit
PCB operating voltage	VCC5V	-	5.0	-	V
LCD I/O operating voltage	VDD	3.0	3.3	3.6	V
Input voltage 'H' level	VIH	2	-	3.6	V
Input voltage 'L' level	VIL	-0.3	-	0.8	V
Output voltage 'H' level	VOH	2.4	-	-	V
Output voltage 'L' level	VOL	-	-	0.4	V

5. TOUCH CHARACTERISTICS

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	1024 × 600	pixel	-
Surface Hardness	≥6H	-	-
Transparency	>82%	-	-
Driver IC	-	-	-
Interface Type	I2C	-	-
Support Points	5	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-



6 ELECTRO-OPTICAL CHARACTERISTICS

TOUCH MODULE

Item of electro-optical characteristics		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	30	40	ms	FIG 1.	4
Contrast F	Ratio	CR	θ=0 Ø=0	-	500	-	-	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	350	-	cd/m2	FIG 2.	2
	White	White x	$\theta=0$	-	0.308	-		FIG 2.	
	vv iiite	White y		_	0.336	_			_
	Red	Red x		-	0.599	-			
CIE(x, y)		Red y		-	0.338	-			
chromaticity		Green x	Ø=0 Ta=25°C	-	0.299	-			5
	Green	Green y	14 25 C	-	0.550	-			
	D1	Blue x		-	0.139	-			
	Blue	Blue y		-	0.131	-			
	Ø=90(1	2 o'clock)		-	85	-	deg		
Viewing	Viewing ∅=270(6		CD > 10	-	85	-	deg	FIC 2	
angle range	Ø=0(3	o'clock)	CR ≥ 10	-	85	-	deg	FIG 3.	6
	Ø=180(9 o'clock)		-	85	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio (CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of



9points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{Minimum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{Maximum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

Note 5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

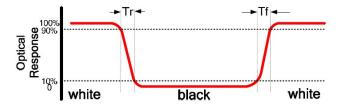


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

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H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

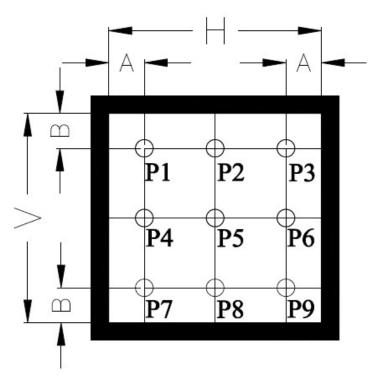
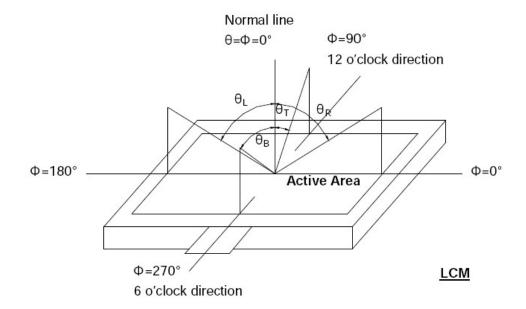


FIG.3. The definition of viewing angle





7. INTERFACE DESCRIPTION

7.1, J1&J2 Interface Description

NO.	Symbol	I/O	DESCRIPTION
1~2	VCC5V	Power supply	Module Power supply (5V Typ.)
3~4	GND	Power supply	Power ground
5	LCD_CS	I	Chip Select pin for 3-wire or 4-wire serial I/F.
6	LCD_MOSI	I	Data input pin of 4-wire SPI I/F.
7	LCD_SCLK	I	Clock of 3-wire or 4-wire serial I/F.
8	LCD_INT	О	The interrupt output for host to indicate the status.
9	LCD_RST	I	This is an active low Reset pin for LCD.
10	LCD_MISO	О	Data output pin of 4-wire SPI I/F. Bi-direction data pin of 3-wire SPI I/F.
11	CTP_INT	О	CTP External interrupt to the host
12	CTP_SCL	I	CTP I2C clock input
13	CTP_SDA	I/O	CTP I2C data input and output
14	CTP_RST	I	CTP external reset signal, Low is active
15	NC	-	No connection
16	GND	Power supply	Power ground
17	NC	-	No connection
18	NC	-	No connection
19	NC	-	No connection
20	GND	Power supply	Power ground

7.2, J3 Interface Description (SPI Flash burning interface)

NO.	Symbol	I/O	DESCRIPTION			
1	SF_CLK	I	Serial Clock Input			
2	SF_DI	I	Data Input			
3	SF_DO	О	Data output			
4	SF_CS	I	Chip Select Input			
5	LCD_RST	I	LCD RESET signal. This pin must be pull low when burning SPI FLASH			
6	GND	Power supply	Power ground			
7	NC	-	No connection			
8	NC	-	No connection			
9~10	3.3V	Power supply	Power supply for the SPI Flash (3.3V Typ.)			



No.	. Test Item Test Condition			
1	High Temperature Storage	80°C/120 hours		
2	Low Temperature Storage	-30°C/120 hours		
3	High Temperature Operating	70°C/120 hours		
4	Low Temperature Operating	-20°C/120 hours		
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles		

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- ➤ Air bubble in the LCD;
- > Sealleak;
- ➤ Non-display;
- Missing segments;
- ➤ Glass crack;
- Current is twice higher than initial value.

B, Remark:

- ➤ The test samples should be applied to only one test item.
- Sample size for each test item is $5\sim10$ pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



9. INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 3.5 inch.

9.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

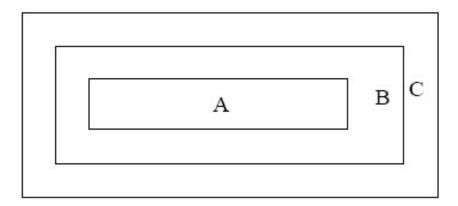
Minor defect: AQL 1.5

9.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40$ W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature $20\sim25^{\circ}$ C and normal humidity 60 $\pm15\%$ RH)

9.3 Definition of Inspection Item.

A. Definition of inspection zone in LCD.



Zone A: character/Digit area

Version: 0.0

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

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Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
	black pattern.
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying
Dark dot	under pure red, green, blue picture, or pure whiter picture.

Major Defect 9.4

Item	Items to be	Inspection standard	Classification
No.	inspected	inspection standard	of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

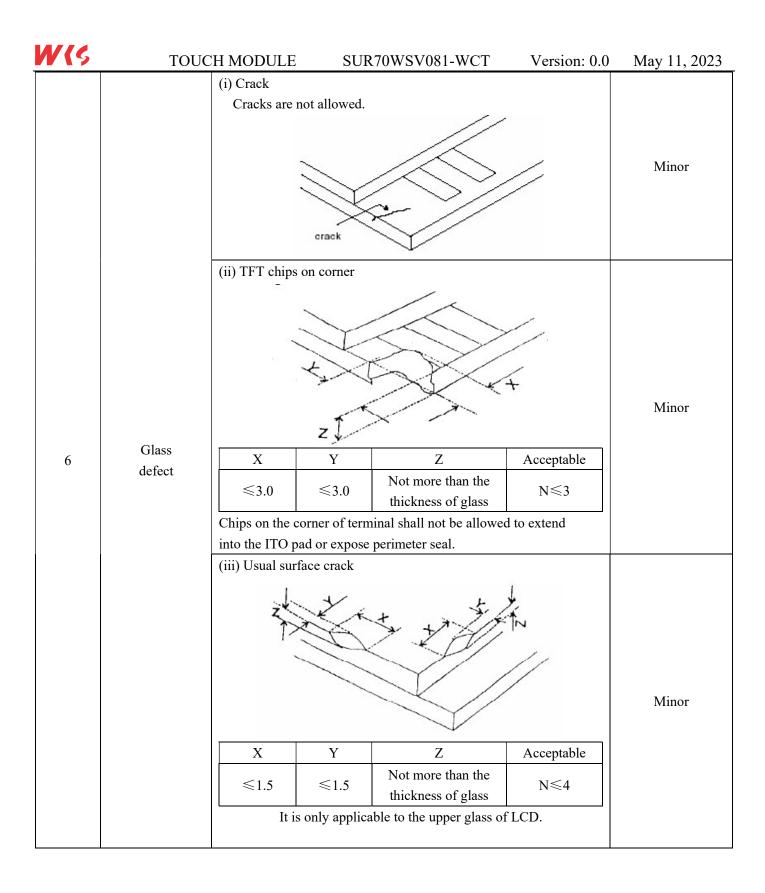
Version: 0.0



9.5 Minor Defect

Item No.	Items to be inspected		Inspection standard							Classification of defects	
			Zone				Accepta	able (Otv		
							A+B		<u>C-J</u>		
					3.5"~	~7"	7~10.1"	,	>10.1"	С	
		Bri	ight pixel do	t	1		2		3		
	Bright dot	Da	ark pixel dot		4		4		4	Acc	
1	/dark dot	2brigh	ıt dots adja	cent	0		0		0	Acceptable	Minor
	defect	2dark	dots adjac	cent	0		0		0	able	
		Total bri	ght and da	rk dots	5		6		7		
		Note: Min	imum dist	ance bet	ween	defec	tive dots	is m	ore than	5mm;	
		Pixel dots	' function	is norma	al, but	brigh	nt dots ca	used	by foreig	gn	
		material a	nd other re	asons ar	re judg	ged by	y the dot	defe	ct of 5.2.	1	
		Zone					ceptable	Qty			
	Dot defect						4+B				
		Size(mm)		3.5"~			~10.1"		>10.1"	С	
		Ф	Ф ≤ 0.2 Accep		table	Acc	eptable	Aco	Acceptable		
2		0.2<Ф≤0.5		4			5		6	Acceptable	Minor
		Ф>0.5		0			0		0	le	
		 Note: 1. Minimum distance between defective dots is more than 5 mm. 2. The quantity of defect is zero in operating condition. 				m;					
			Zone			Ac	ceptable	Qty			
		Size (mn	n)			1	A +B				
2	Linear	Length	Width	3.5"~	~7"	7~	~10.1"	>	>10.1"	С	Minor
3	defect	Ignore	W≤0.05	Accept	table	Acc	eptable	Acc	ceptable	Ac	IVIIIIOI
		L≤5.0	0.05 < W≤0.1	4			5		6	Acceptable	
		L>5.0	W>0.1	0			0		0	e	

W(S	TOUC	CH MODUI	LE	SUR70WS	V081-WCT	Versi	on: 0.0	May 11, 2023	
4	Polarizer defect	dimension. (ii) Incomp allowed. 5.4.2 Dirt of Dirt which 5.4.3 Polari Size(mm) $\Phi \leq 0.2 < \Phi$ $\Phi > 5.4.4 Polari (i) If the poor in the of (ii) If the poor in the of (ii) If the poor in the of (iii) If the poor in the of (iiii) If the poor in the of (iii) If the poor in the of (iii) If the poor in the of (ii$	in position lette cover on polarizer can be writer Dent Zone 0.2 	on should not or ring of the vie er iped easily shows Air bubble 3.5"~7" Acceptable 4	Acceptable A+B 7~10.1" Acceptable 5 0 e seen after codge by the live seen only in the	oto shifting is table. Qty >10.1" Acceptable 6 0 cover assemble near defect of in non-operate following:	C Acceptable of 5.3.	Minor	
5	MURA	Using 3% ND filter, it's NG if it can be seen in R,G,B picture.						Minor	
5	White/Black dot (MURA)		Visible under: ND3%; D \leq 0.15mm, Acceptable; 0.15mm $<$ D \leq 0.5mm, N \leq 4; D>0.5mm, Not allowable.						



9.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing	Major
		No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil (Φ0.5 mm or more) on substrate	74.
		pattern is not allowed	Minor
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
	Backlight plastic	No deformation, crack, breaking, backlight positioning column	Minor
6	frame	breaking, obvious nick.	
7	Marking printing	No dark marking, incomplete, deformation lead to	Minor
	effect	unable to judge	
	Accretion of	, <u>, , , , , , , , , , , , , , , , , , </u>	
8	metallic	No accretion of metallic foreign matter (Not exceed Φ0.2mm)	Minor
	Foreign matter		
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor
11	3. Chips	(3/2) H ≥h ≥(1/2) H	Minor
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h \geq 0.13 mm. The diameter of solder ball d \leq 0.15 mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major